

# Product data sheet

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Semiconductor Compiance

Schematic Diagram

#### Specification Features

- Small Body Outline Dimensions: nom 0.039" x 0.024" (1.0x0.6 mm)
- Low Body Height: nom 0.0 19" (0.5 mm)
- Low Capacitance 15 pF
- Low Clamping Voltage
- Reverse Working (Stand-off) Voltage: 5V
- Low Leakage
- Response Time is Typically < 1 ns
- IEC61000-4-2 Level 4 ESD Protection
- This is a Pb-Free Device

#### Mechanical Characteristics:

- CASE: Void-free, transfer-molded, thermosetting plastic Epoxy Meets UL 94 V-0
- LEAD FINISH: NiPdAu
- MOUNTING POSITION: Any
- QUALIFIED MAX REFLOW TEMPERATURE: 260°C
- Device Meets MSL 1 Requirements
- RoHS/WEEE Compliant
- Marking: Marking code

#### Applications

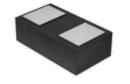
- Cellular Handsets & Accessories
- Personal Digital Assistants (PDAs)
- Notebooks & Handhelds
- Portable Instrumentation
- Digital Cameras
- Peripherals
- MP3 Players

#### ELECTRICAL CHARACTERISTICS

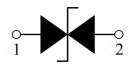
P/N	V <sub>RWM</sub> (V)	I <sub>R1</sub> (µА) @ V <sub>RWM</sub>	<b>I<sub>R2</sub>(µA)</b> @ V <sub>R</sub> =3.5∨	V <sub>BR</sub> (V (Not		Гт	Vc (V) @ IPP = 1 A (Note 3)	Vc (V) @MAX IPP (Note 3)	<b>Ірр(А)</b> (Note 3)	<b>Р<sub>РК</sub>(W)</b> (Note 3)	C (pF)
	Мах	Мах	Мах	Min	Мах	mA	Мах	Мах	Max	Мах	Max
AZ5725-01F-MS	5.0	0.5	0.3	5.6	8.0	1.0	9.8	12.5	5.5	69	15

#### **Maximum Ratings**

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Contact		±30	kV
Peak Power Per 8 x 20µs Waveform	P <sub>PK</sub>	70	W
Total Power Dissipation on FR-5 <sup>®</sup> Board @ TA = 25°C	PD	300	mW
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Lead Solder Temperature - Maximum (10 Second Duration)	TL	260	°C



**Pin Description** 



DFN1006P2X





### **Electrical Parameter**

Symbol	Parameter
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
V <sub>RWM</sub>	Working Peak Reverse Voltage
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>
Ιτ	Test Current
V <sub>BR</sub>	Breakdown Voltage @ I⊤

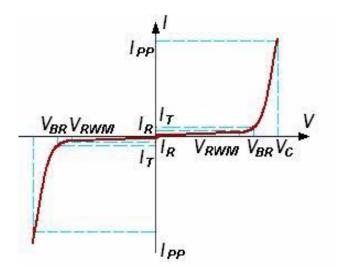
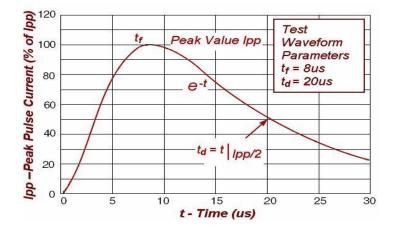
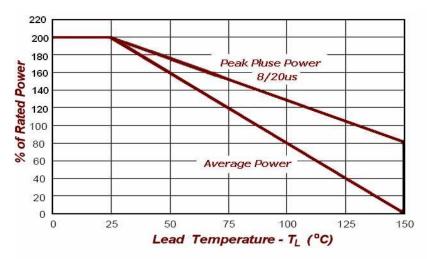


FIG1: Pulse Waveform



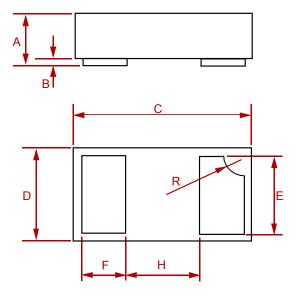






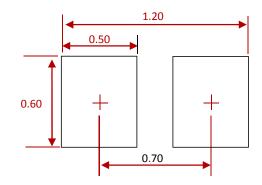
AZ5725-01F-MS HF Compiance

## PACKAGE MECHANICAL DATA



Dim	Inc	hes	Millimeters		
Dim	MIN MAX		MIN	MAX	
A	0.0125	0.02	0.32	0.52	
В	0.000	0.002	0.00	0.05	
С	0.037	0.043	0.95	1.080	
D	0.022	0.027	0.55	0.680	
E	0.016	0.024	0.40	0.60	
F	0.008	0.012	0.20	0.30	
н	0.01	5Тур.	0.40Тур.		
R	0.001	0.005	0.05	0.15	

# **Suggested Pad Layout**



NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

### **REEL SPECIFICATION**

P/N	PKG	QTY
AZ5725-01F-MS	DFN1006P2X	10000





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